

DECLARATION AND POWER OF ATTORNEY U.S.A.

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ALL PATENTS, INCLUDING DESIGN FOR APPLICATION BASED ON PCT: PARIS CONVENTION; NON PRIORITY; OR PROVISIONAL APPLICATIONS

	malter which is	As a below named inventor, I declare that my residence, post office address and citizenship are stated below next to my name, the information given herein is true, that I believe that I am the original first and sole inventor (if only one name is listed at 201 below), or an original, first and joint inventor (if plural inventors are named below at 201-203, or on additional sheets attached hereto) of the sumatter which is claimed and for which patent is sought on the invention entitled: STACK CHIP MODULE									
r	┥ ───	CHIP MODULE				 -		· 			
1	which is descri	ped and daimed in:	PCT	International Applica	tian Na.			filed			
	the attached specification the			PCT International Application No. the specification in application Serial No. (if applicable) and amended on							
							 """.				
	I hereby daim f foreign applicat	I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by a I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, §1.56. I hereby claim foreign priority benefits under Title 35, United States Code, §119 (a)-(d) of any foreign application(s) for patent or inventor's of foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:									
	Prior Foreign Application(s) 2001-52870			Republic of Korea		30,	30/08/2001		Priority Claimed		
103	(Number)		(0	Country)	(Day)		lonth/Year Filed)		Yes No		
	(Number)			Country)		(Day/N	lonth/Year Filed)	Ļ	/es	No	
_	(Number)	(Number)		(Country)		(Day/Month/Year Filed)			Yes No		
5	I hereby daim to		code,§119(e) of any U Filing Date	United States provisional application(s) listed below: Application No.		_					
105	I hereby daim the disclosed in the patentability as application:	I have been the benefit under Title 35. United States Code, §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application discipsed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose information which is patentability as defined in Title 37, Code of Federal Regulations, §1.56 which became available between the filing date of the prior application and the national or PCT international filing date of the prior application.									
١	ال الله ال	oplication Serial No.)			(Filing Date)	 -	(State	s: patented, pe	odion abs	andoned)	
	PROFESSIONAL LIN 400 SEVEN WASHING		COBS NAL LIMI SEVENT ASHINGT	or SON HOLMAN MITED LIABILITY COMPANY NTH STREET, N.W. 3TON, D.C. 20004				DE LIABILITY COMPANY			
III	FULL NAME *	IDENCE & CITY IZENSHIP Kyoungki-do T OFFICE POST OFFICE ADDRESS		ated first or middle	GNEN NAME	SIVEN NAME		MIDDLE NAME			
_					Joon Ki STATE OR FOREIGN COUNTRY Republic of Korea CITY Daewol-myon, Ich'on, K				OUNTRY OF CITIZENSHIP Republic of Korea		
2	CITIZENSHIP						orea	Popul			
	ADDRESS			6th Apt.,			NIAI	SIALEGEROUNI		DV ZID CODE	
	FULL NAME * OF INVENTOR	R CITY			GIVEN NAME	· · · · · · · · · · · · · · · · · · ·		MIDDLE NAM	1E		
703	RESIDENCE & CITIZENSHIP				STATE OR FOREIGN COUNTRY		TRY	COUNTRY OF C		ITIZENSHIP	
	POST OFFICE ADDRESS						STAT	OR COUNT	RY	ZIP CODE	
203	FULL NAME * OF INVENTOR	FAMILY NAME			GIVEN NAME			MIDDLE NAME			
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ä١	ements were mad	all statements made herein de with the knowledge tha and that such willful false	t willful fa	ise statements and	l the like so made are i	ounishable	empositami to enil vd	nt or both und	l to be tra ler section	ue; and further that the on 1001 of Title 18 of	
iC	SNATURE OF IN	VENTOR 201°		SIGNATURE O	OF INVENTOR 202° SIGNATUR			E OF INVENTOR 203°			
A	TE Decem	per 13, 2001		DATE			DATE				
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